



MP3H7 Series

SSOP4, DC Input, Photo Transistor Coupler

■ Features

- High isolation 3750 VRMS
- CTR flexibility available see order information
- DC input with transistor output
- Operating temperature range - 55 °C to 110 °C
- REACH Compliance
- Halogen free
- MSL class 1
- Regulatory Approvals
 - UL - UL1577
 - VDE - EN60747-5-5(VDE0884-5)
 - CQC – GB4943.1-2022

■ Applications

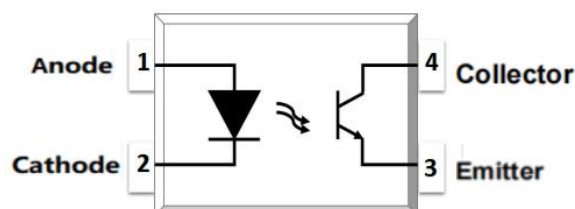
- Switch mode power supplies
- Programmable controllers
- Household appliances
- Office equipment

■ Description

The MP3H7 series combine an AlGaAs infrared emitting diode as the emitter which is optically coupled to a silicon planar phototransistor detector in a plastic SSOP4 package with different lead forming options.

With the robust coplanar double mold structure, MP3H7 series provide the most stable isolation feature.

■ Schematic





MP3H7 Series
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ABSOLUTE MAXIMUM RATINGS				
PARAMETER	SYMBOL	VALUE	UNIT	NOTE
INPUT				
Forward Current	I_F	60	mA	
Peak Forward Current	I_{FP}	1	A	1
Reverse Voltage	V_R	6	V	
Input Power Dissipation	P_I	100	mW	
OUTPUT				
Collector - Emitter Voltage	V_{CEO}	80	V	
Emitter - Collector Voltage	V_{ECO}	7	V	
Collector Current	I_C	50	mA	
Output Power Dissipation	P_O	150	mW	
COMMON				
Total Power Dissipation	P_{tot}	200	mW	
Isolation Voltage	V_{iso}	3750	V _{rms}	2
Operating Temperature	T_{opr}	-55~110	°C	
Storage Temperature	T_{stg}	-55~125	°C	
Soldering Temperature	T_{sol}	260	°C	

Note 1. 100μs pulse, 100Hz frequency

Note 2. AC For 1 Minute, R.H. = 40 ~ 60%



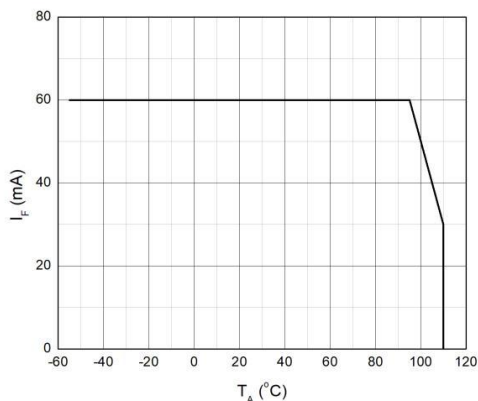
MP3H7 Series
SSOP4, DC Input, Photo Transistor Coupler

ELECTRICAL OPTICAL CHARACTERISTICS at Ta=25°C							
PARAMETER	SYMBOL	MIN	TYP.	MAX.	UNIT	TEST CONDITION	NOTE
INPUT							
Forward Voltage	V_F	-	-	1.4	V	$I_F=10\text{mA}$	
Reverse Current	I_R	-	-	10	μA	$V_R=6\text{V}$	
Input Capacitance	C_{in}	-	10	-	pF	$V=0, f=1\text{kHz}$	
OUTPUT							
Collector Dark Current	I_{CEO}	-	-	100	nA	$V_{CE}=20\text{V}, I_F=0$	
Collector-Emitter Breakdown Voltage	BV_{CEO}	80	-	-	V	$I_C=0.1\text{mA}, I_F=0$	
Emitter-Collector Breakdown Voltage	BV_{ECO}	7	-	-	V	$I_E=0.1\text{mA}, I_F=0$	
TRANSFER CHARACTERISTICS							
Current Transfer Ratio	MP3H7	CTR	50	-	600	$I_F=5\text{mA}, V_{CE}=5\text{V}$	
	MP3H7A		80	-	160		
	MP3H7B		130	-	260		
	MP3H7C		200	-	400		
	MP3H7D		300	-	600		
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	-	0.1	0.2	V	$I_F=10\text{mA}, I_C=1\text{mA}$	
Isolation Resistance	R_{ISO}	10^{12}	10^{14}	-	Ω	DC500V, 40 ~ 60% R.H.	
Floating Capacitance	C_{IO}	-	0.4	1	pF	$V=0, f=1\text{MHz}$	
Response Time (Rise)	t_r	-	3	18	μs	$V_{CE}=2\text{V}, I_C=2\text{mA}$	3
Response Time (Fall)	t_f	-	4	18	μs	$R_L=100\Omega$	3
Cut-off Frequency	f_c	-	80	-	kHz	$V_{CE}=2\text{V}, I_C=2\text{mA}$ $R_L=100\Omega, -3\text{dB}$	4

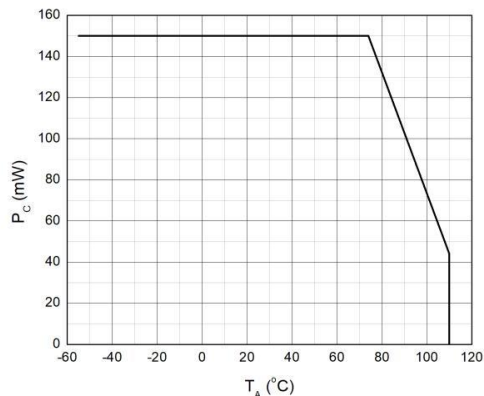
Note 3. Fig.12&13

Note 4. Fig.14

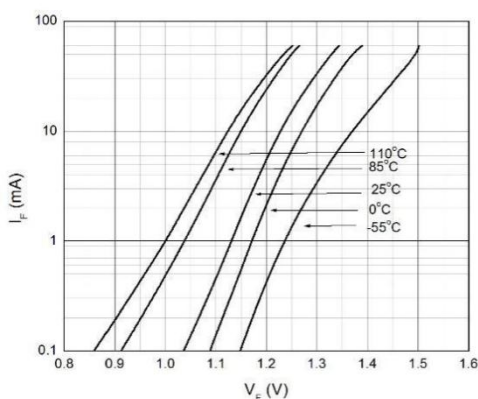
CHARACTERISTIC CURVES



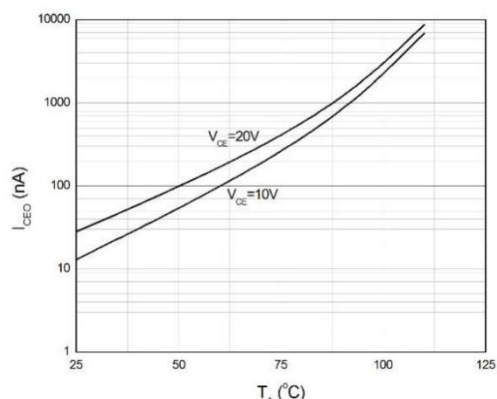
**Fig.1 Forward Current
vs. Ambient Temperature**



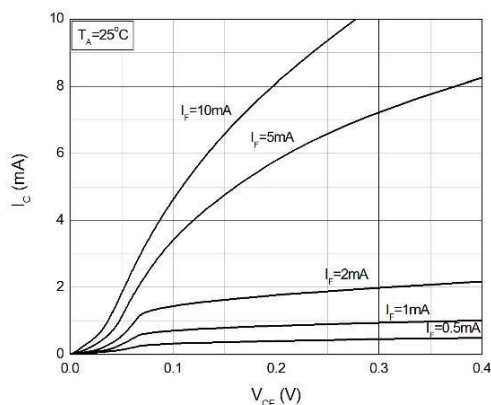
**Fig.2 Collector Power Dissipation
vs. Ambient Temperature**



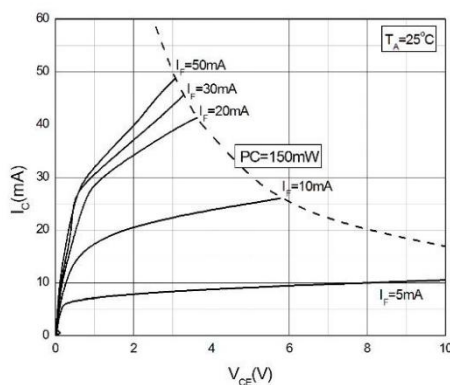
**Fig.3 Forward Current
vs. Forward Voltage**



**Fig.4 Collector Dark Current
vs. Ambient Temperature**



**Fig.5 Collector Current
vs. Collector-emitter Voltage**



**Fig.6 Collector Current
vs. Collector-emitter Voltage**

CHARACTERISTIC CURVES

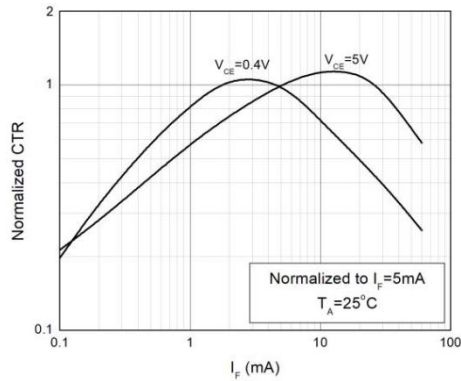


Fig.7 Normalized Current Transfer Ratio vs. Forward Current

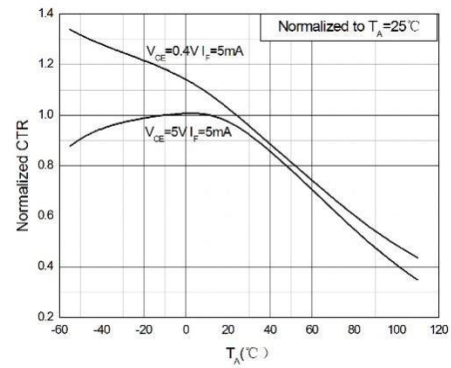


Fig.8 Normalized Current Transfer Ratio vs. Ambient Temperature

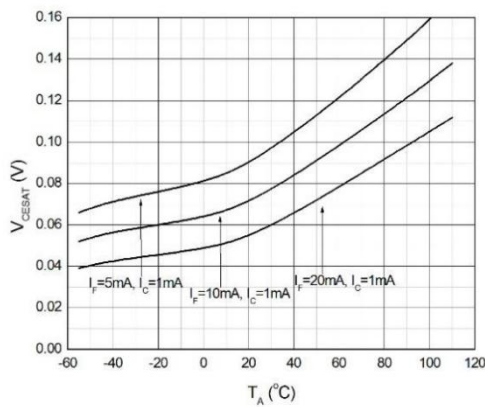


Fig.9 Collector-emitter Saturation Voltage vs. Ambient Temperature

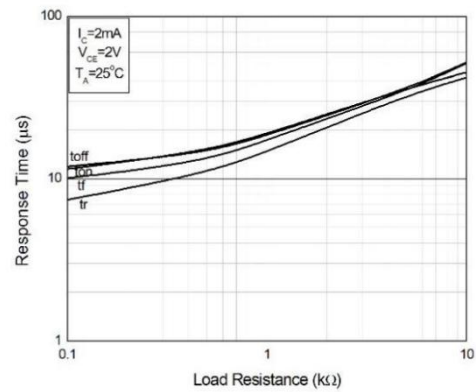


Fig.10 Switching Time vs. Load Resistance

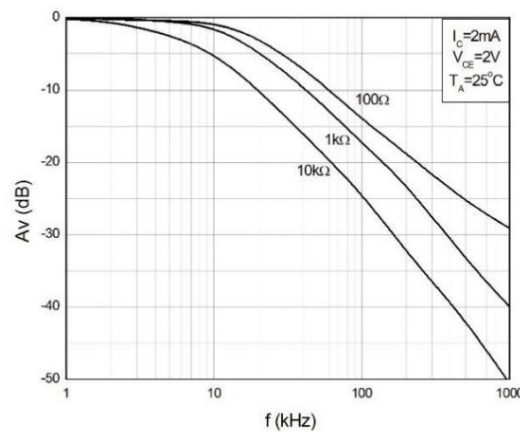


Fig.11 Frequency Responses

TEST CIRCUITS

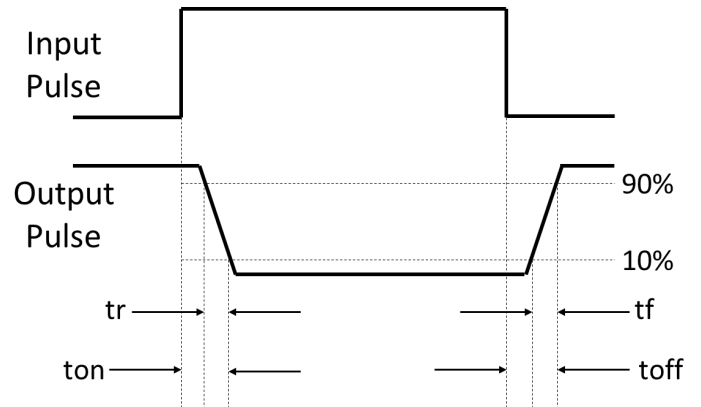
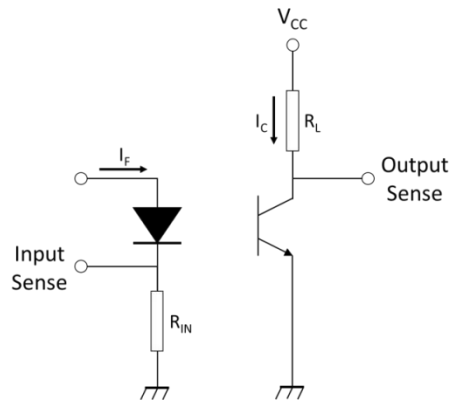


Fig.12 Test Circuits of Response Time

Fig.13 Curves of Response Time

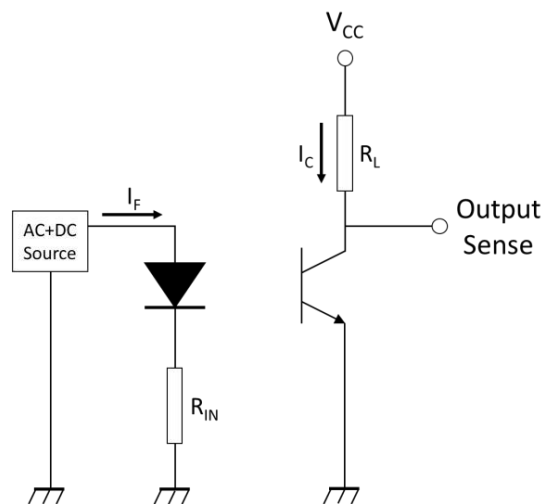
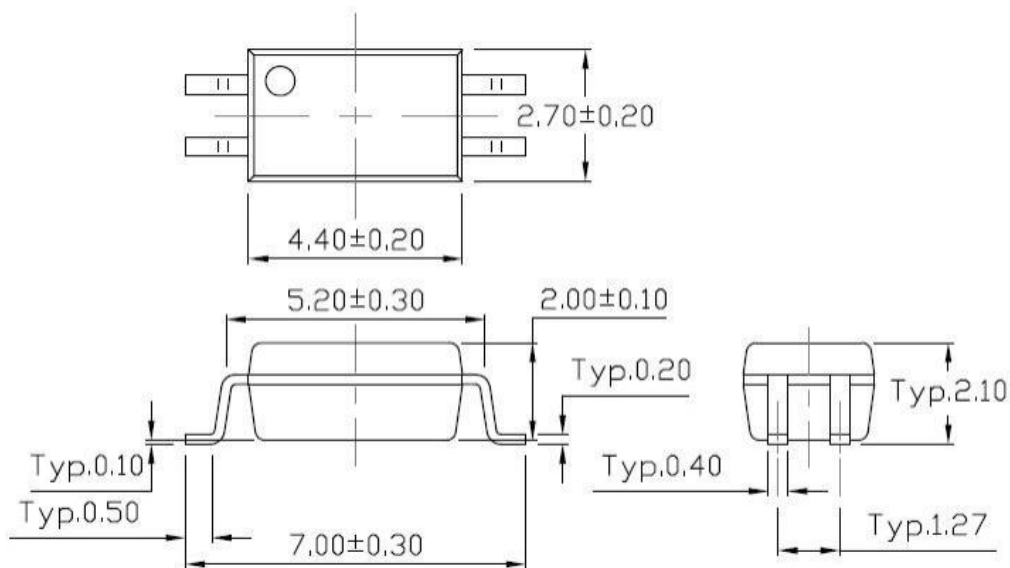
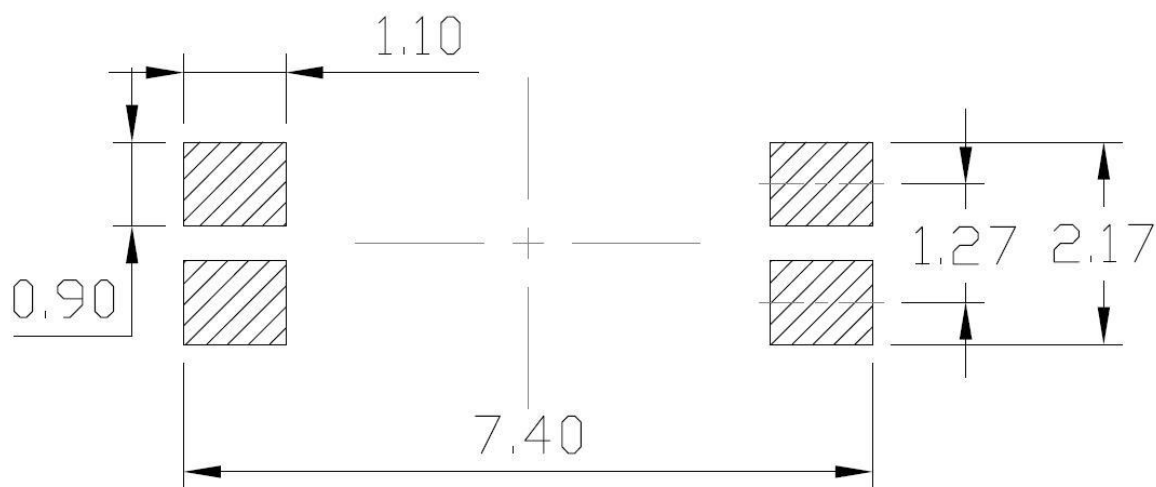


Fig.14 Test Circuits of Frequency Response

PACKAGE DIMENSIONS (Dimensions in mm unless otherwise stated)

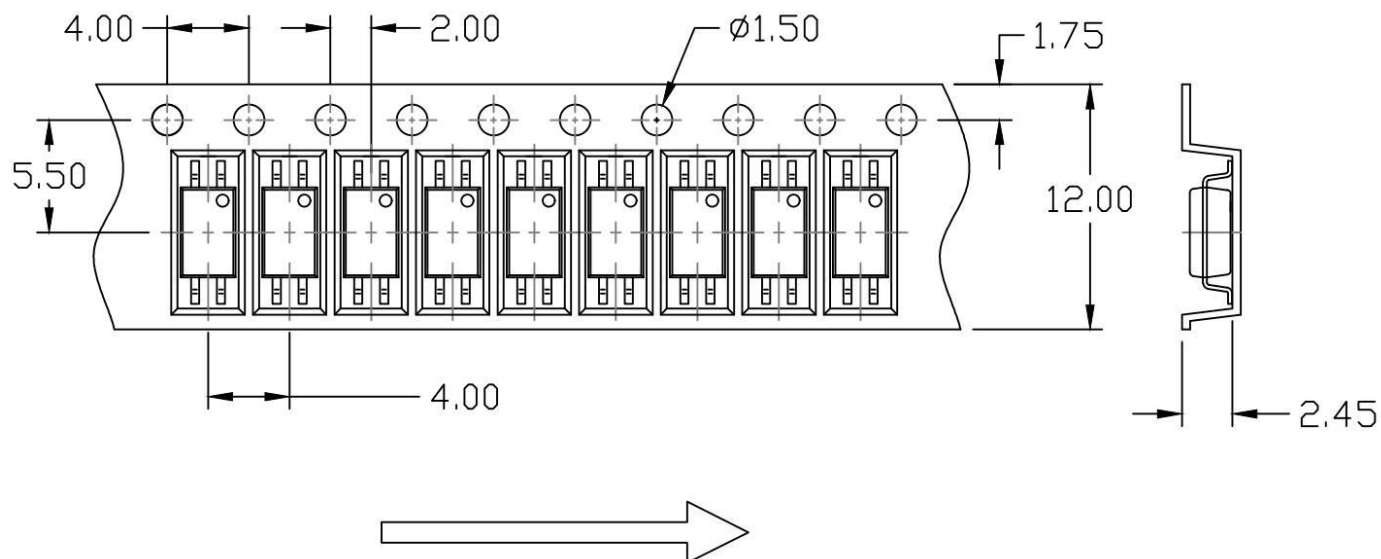


Recommended Solder Mask (Dimensions in mm unless otherwise stated)

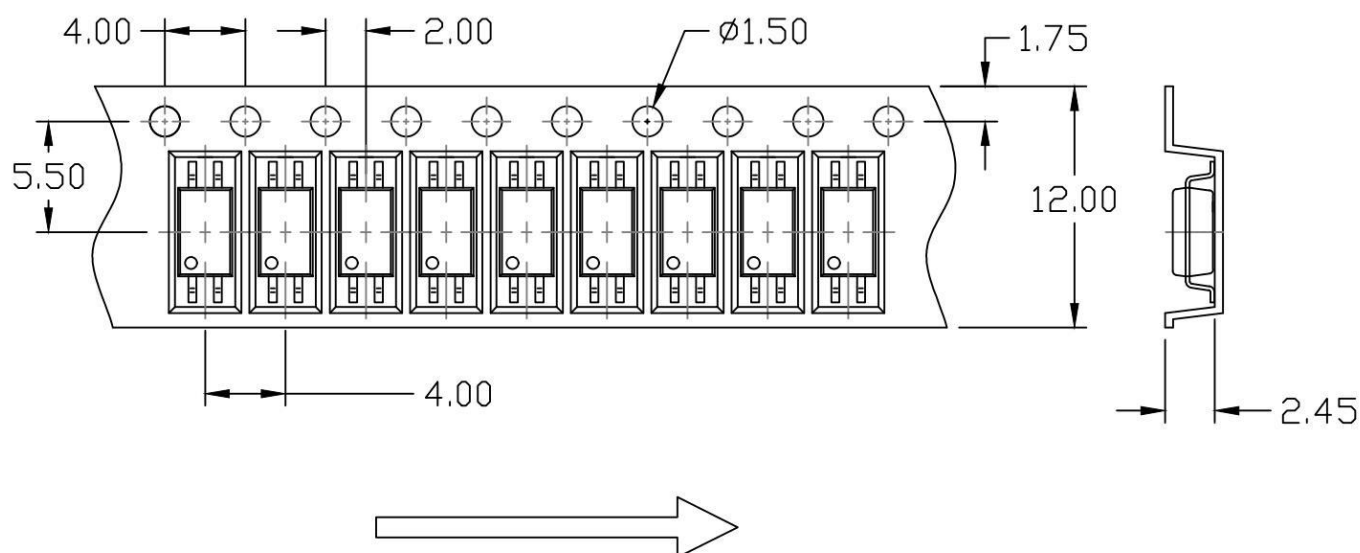


CARRIER TAPE SPECIFICATIONS (Dimensions in mm unless otherwise stated)

Option T1

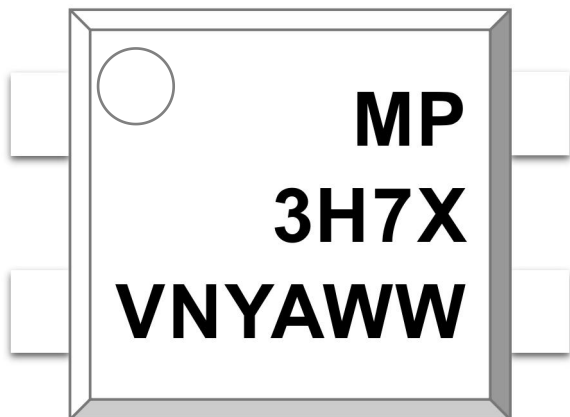


Option T2



ORDERING AND MARKING INFORMATION

MARKING INFORMATION



MP :Company Abbr.
3H7 :Part Number
X :CTR Rank
V :VDE Option
N :Version Number or None
Y :Fiscal Year
A :Manufacturing Code
WW :Work Week

ORDERING INFORMATION

MP3H7X(Z)-GV(XN)

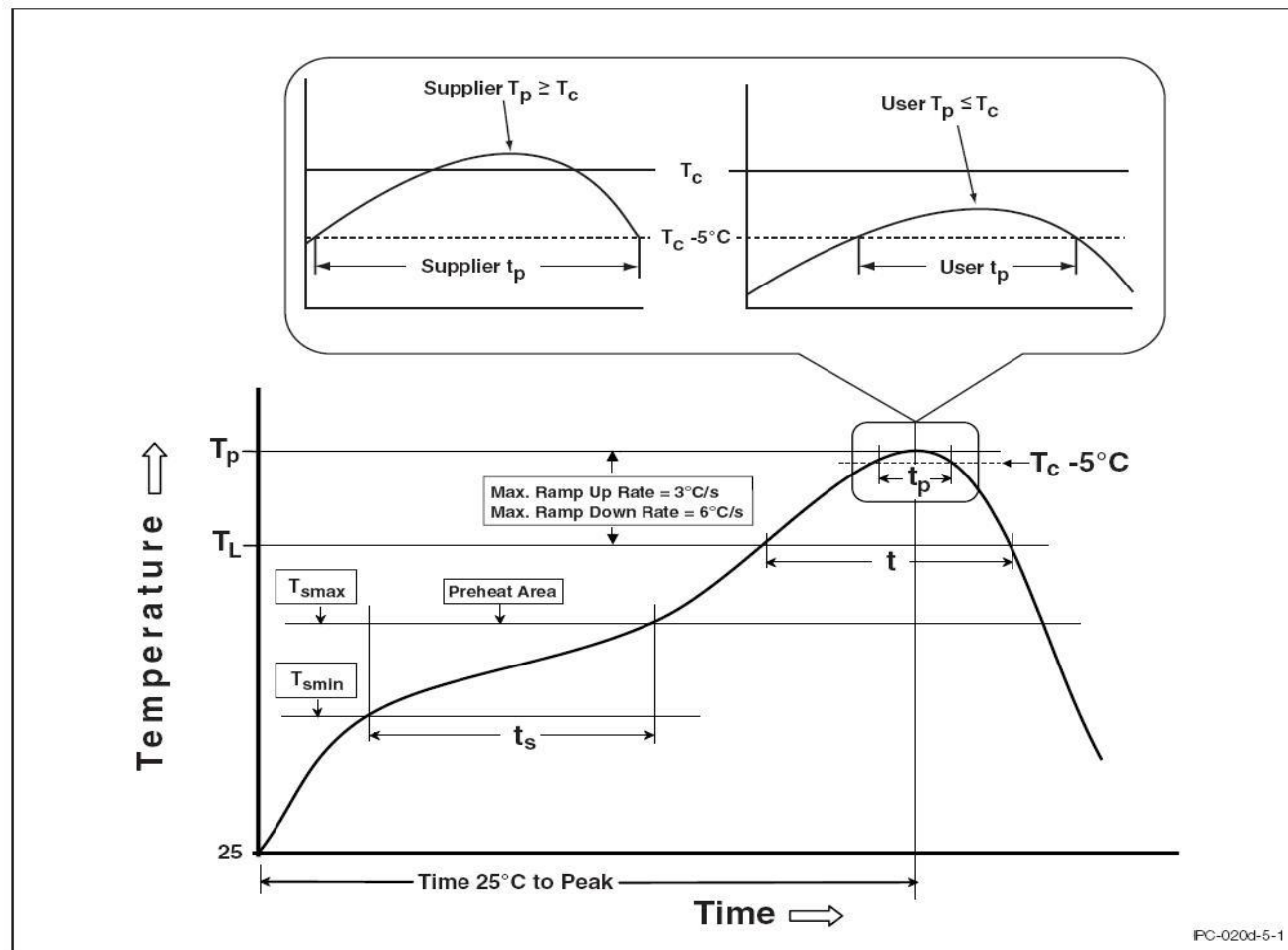
MP – Company Abbr.
 3H7 – Part Number
 X – Rank (A/B or None)
 Z – Tape and Reel Option (T1/T2)
 G – Material Option (G: Green, None: Non-Green)
 V – VDE Option (V or None)
 X – Rank (A~Z or None)
 N – Version Number(0~9 or None)

PACKING QUANTITY

Option	Quantity	Quantity – Inner box	Quantity – Outer box
T1	3000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 45k Units
T2	3000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 45k Units

REFLOW INFORMATION

REFLOW PROFILE



Profile Feature	Sn-Pb Assembly Profile	Pb-Free Assembly Profile
Temperature Min. (T _{min})	100	150°C
Temperature Max. (T _{max})	150	200°C
Time (t _s) from (T _{min} to T _{max})	60-120 seconds	60-120 seconds
Ramp-up Rate (t _L to t _P)	3°C/second max.	3°C/second max.
Liquidous Temperature (T _L)	183°C	217°C
Time (t _L) Maintained Above (T _L)	60 – 150 seconds	60 – 150 seconds
Peak Body Package Temperature	235°C +0°C / -5°C	260°C +0°C / -5°C
Time (t _P) within 5°C of 260°C	20 seconds	30 seconds
Ramp-down Rate (T _P to T _L)	6°C/second max	6°C/second max
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.



DISCLAIMER

- Our company is continually improving the quality, reliability, function and design. Our company reserves the right to make changes without further notices.
- The characteristic curves shown in this datasheet are representing typical performance which are not guaranteed.
- This product is not intended to be used for military, aircraft, automotive, medical, life sustaining or lifesaving applications or any other application which can result in human injury or death.
- Immerge unit's body in solder paste is not recommended.
- Discoloration might be occurred on the package surface after soldering, reflow or long-time use. It neither impacts the performance nor reliability.

■ Revision History

Version	Date	Subjects (major changes since last revision)
0.1	2023-07-05	Datasheet Complete
0.2	2023-08-09	Datasheet Upgrade
0.3	2023-11-03	Datasheet Upgrade
1.0	2025-04-09	Datasheet Upgrade